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Should be replaced with:

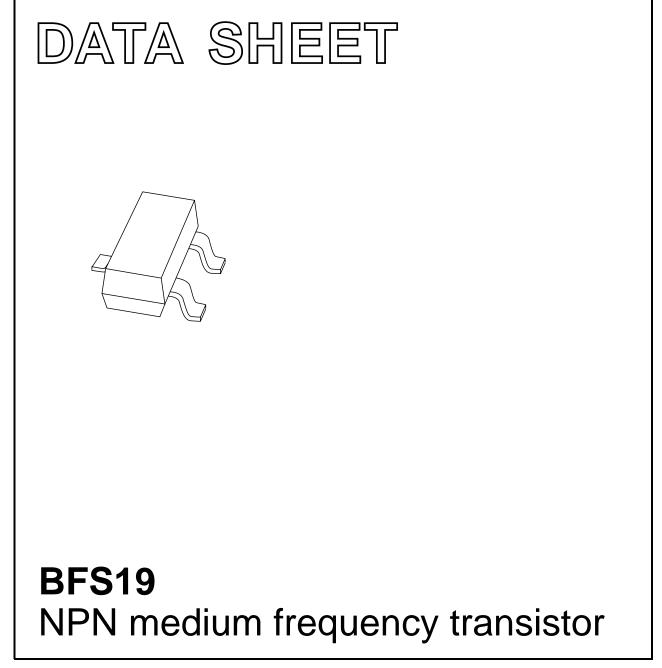
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If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 1999 Apr 15 2004 Jan 05



FEATURES

- I_{C(max)} = 25 mA
- V_{CEO(max)} = 20 V.

APPLICATIONS

• Medium frequency applications in thick and thin-film circuits.

DESCRIPTION

NPN medium frequency transistor in a SOT23 plastic package.

MARKING

| TYPE NUMBER | MARKING CODE ⁽¹⁾ | | |
|-------------|-----------------------------|--|--|
| BFS19 | F2* | | |

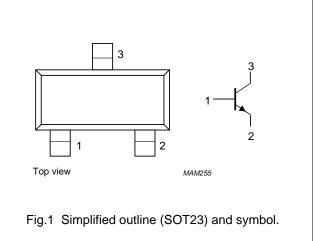
Note

- 1. * = p : Made in Hong Kong.
 - * = t : Made in Malaysia.
 - * = W : Made in China.

ORDERING INFORMATION

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|--|
| 1 | base | |
| 2 | emitter | |
| 3 | collector | |



| TYPE | PACKAGE | | |
|--------|---------|--|-------|
| NUMBER | NAME | NAME DESCRIPTION VE | |
| BFS19 | _ | plastic surface mounted package; 3 leads | SOT23 |

BFS19

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------------|--|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | _ | 30 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 20 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I _C | collector current (DC) | | - | 30 | mA |
| I _{CM} | peak collector current | | - | 30 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \text{ °C}; \text{ note } 1$ | - | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | operating ambient temperature | | -65 | +150 | °C |

Note

1. Transistor mounted on an FR4 printed-circuit board.

BFS19

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT | |
|----------------------|---|------------|-------|------|--|
| R _{th(j-a)} | thermal resistance from junction to ambient | note 1 | 500 | K/W | |

Note

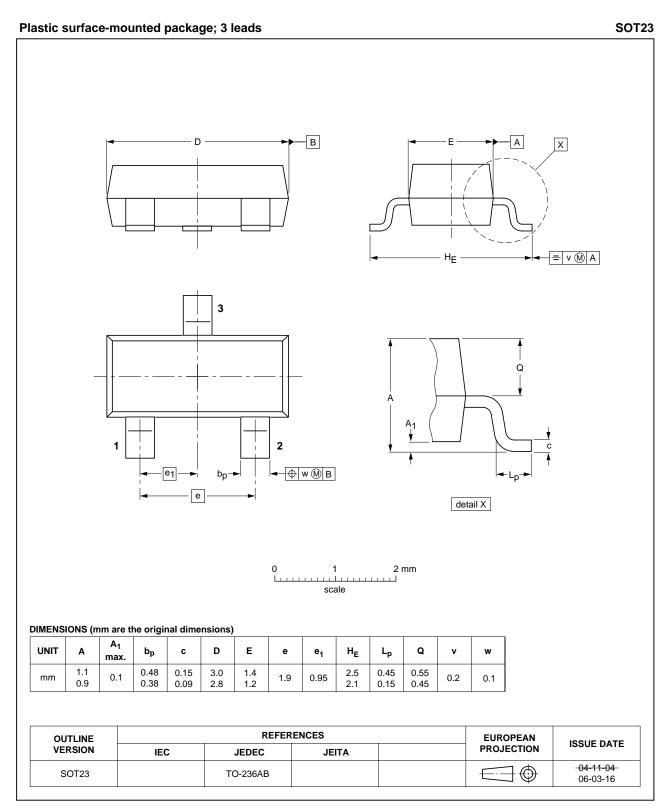
1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|---------------------------|---|------|------|------|------|
| I _{CBO} | collector cut-off current | I _E = 0; V _{CB} = 20 V | - | - | 100 | nA |
| | | I _E = 0; V _{CB} = 20 V; T _j = 100 °C | - | - | 10 | μA |
| I _{EBO} | emitter cut-off current | I _C = 0; V _{EB} = 5 V | - | - | 100 | nA |
| h _{FE} | DC current gain | I _C = 1 mA; V _{CE} = 10 V | 65 | _ | 225 | |
| V _{BE} | base-emitter voltage | I _C = 1 mA; V _{CE} = 10 V | 650 | _ | 740 | mV |
| C _c | collector capacitance | I _E = 0; V _{CB} = 10 V; f = 1 MHz | - | 1 | _ | pF |
| C _{re} | feedback capacitance | I _C = 0 mA; V _{CB} = 10 V; f = 1 MHz | - | 0.85 | _ | pF |
| f _T | transition frequency | I _C = 1 mA; V _{CE} = 10 V; f = 100 MHz | - | 260 | _ | MHz |

PACKAGE OUTLINE



BFS19

BFS19

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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NXP Semiconductors

Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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